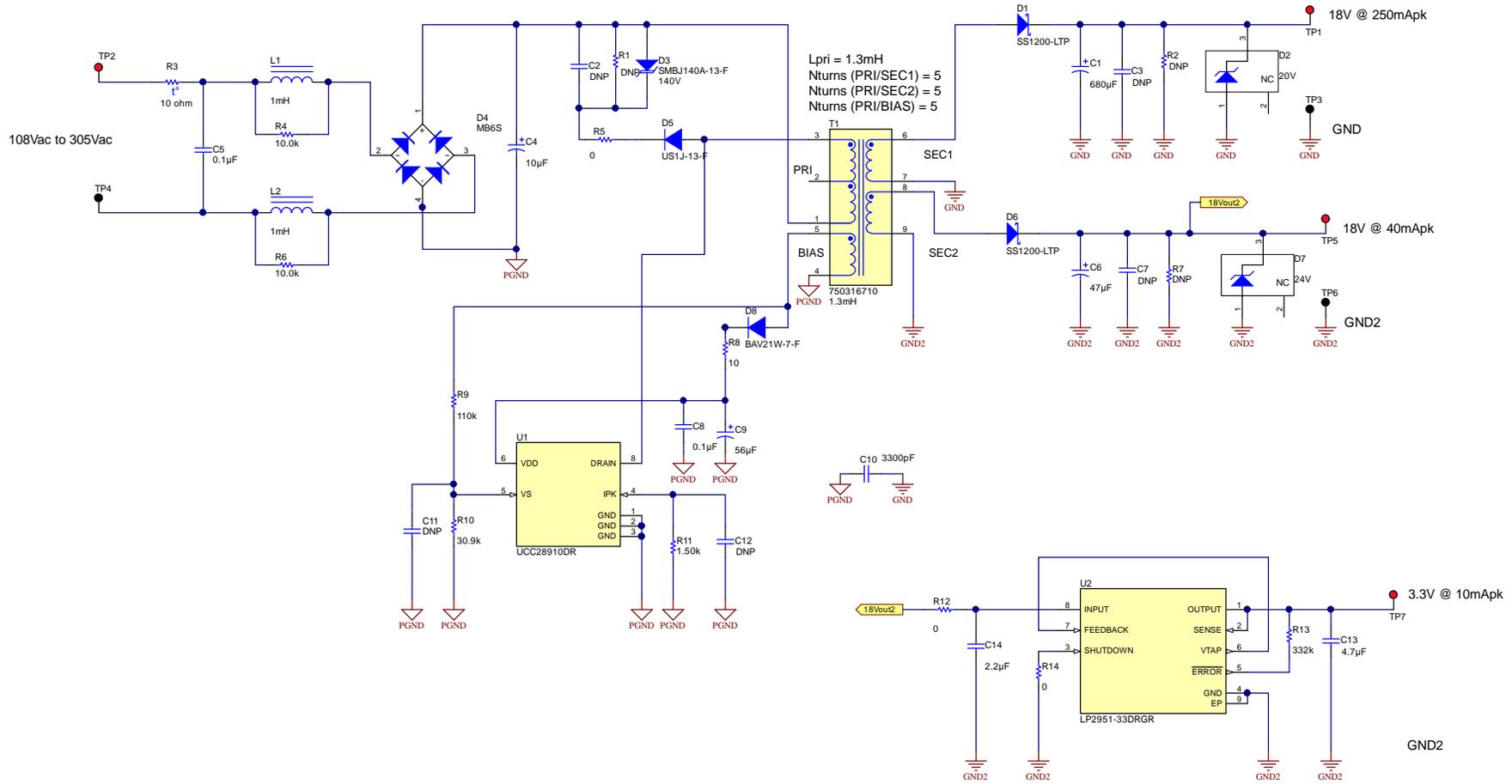


HIGH VOLTAGE!



Notes:

- DNP = "DO NOT POPULATE"
- Built on board PMP30198_RevA

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